

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com











RJ45 transmitter sockets (magnetics) for gigabit applications (1000 base-T) with integrated compensation actively counteracts inductive and capacitive couplings and saves space on the PCB.

The product range encompasses the following designs:

- 90°, lying (horizontal) and 180°, standing (vertical)
- latch up / latch down
- THT, THR or SMD soldering processes
- Wide range of different design types, also with integrated LEDs and shield contact tabs
- Transmission rates of up to 1 Gbps
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- \bullet Compatible with modular RJ45 connector according to ANSI / TIA-1096-A and IEC 60603
- Dielectric strength ≥1500 V AC RMS (2250 V AC peak value) according to IEEE 802.3
- Dielectric strength ≥1500 V AC (peak value) or ≥1500 V DC according to IEC 60603
- Compliance with IEEE 802.3 requirements (1000Base-T, 1 Gbps, IEEE 802.3ab or 100Base-Tx, 100 Mbps, IEEE 802.3u)

Properties and advantages:

- \bullet Extended temperature range of –40 °C to +85 °C for maximum performance
- \bullet Reinforced gold layer (30 μ ") for improved corrosion protection

At least 0.3mm stand-off ensures a perfect soldering result

General ordering data

Version	PCB plug-in connector, RJ45 jacks transformer,		
	100 MBit/s, POE, THT/THR solder connection,		
	90°, Latch option: bottom, Number of poles: 10,		
	Tray (manual assembly)		
Order No.	<u>2661700000</u>		
Туре	RJ45MP R1D 3.3E4G/Y TY		
GTIN (EAN)	4050118675160		
Qty.	120 pc(s).		
Packaging	Tray (manual assembly)		

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Technical data

Net weight	8.125 g		
System specifications			
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Latch option	bottom	Mounting onto the PCB	THT/THR solder connection
Number of poles	10	Outgoing elbow	90°
Performance-Category	100 MBit/s, POE	Pitch in inches (P)	0.05 inch
Pitch in mm (P)	1.27 mm	Product family	OMNIMATE Data - RJ45 transformer jack
Protection degree	IP20	Soldering process	Reflow soldering, Manual soldering, Wave soldering
Transmission rate	100 MBit/s, POE		
Electrical properties			
Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	1500 V DC
Packing			
Packaging	Tray (manual assembly)	VPE length	315 mm
VPE width	190 mm	VPE height	60 mm
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
Approvals			
ROHS	Conform		
	Conform		
Downloads Engineering Data	Conform		



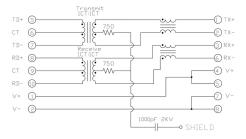
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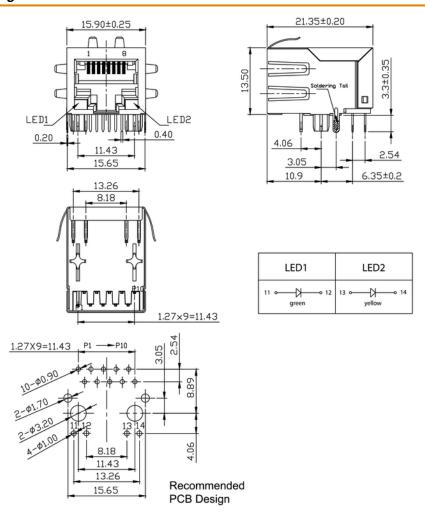
Drawings

Wiring



100 Mbit/s & PoE

Dimensional drawing





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Drawings

Characteristics

Inductance 350 µH min. @ 100 kHz,

100 mV, 8 mA DC Bias

 Leakage Inductance
 0.3 μH max. @ 100 kHz,100 mV

 Insertion Loss
 1.1 dB max. @ (1 - 100) MHz

 Return Loss
 18 dB min. @ (1 - 30) MHz

 16 dB min. @ (30 - 60) MHz

12 dB min. @ (60 - 80) MHz

Cross Talk 30 dB min. @ (1 - 100) MHz Common Mode Rejection 30 dB min. @ (1 - 100) MHz

Type codes



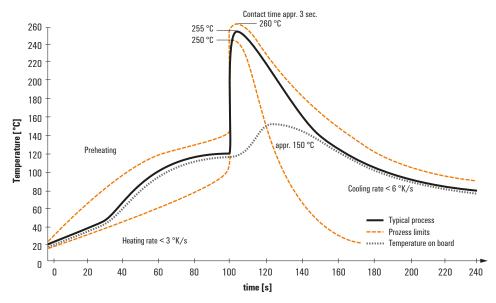
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

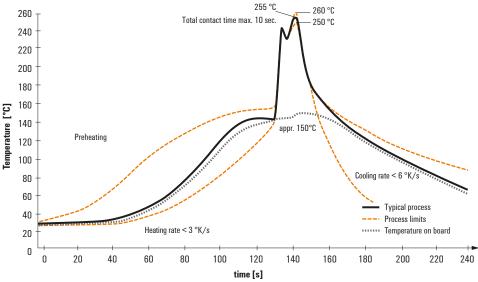
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

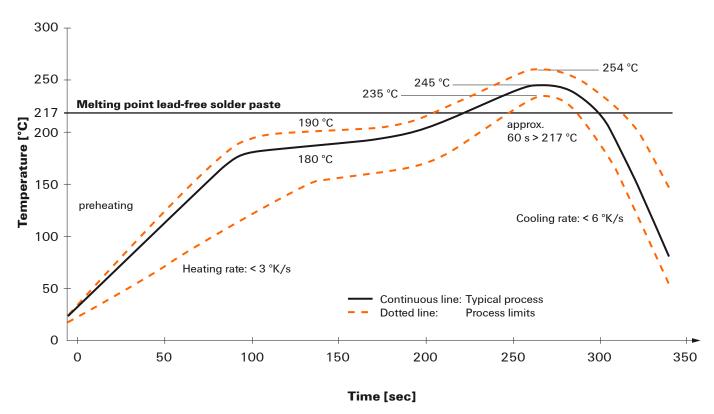


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.